



80V N-CHANNEL ENHANCEMENT MODE MOSFET PowerDI5060-8

Product Summary

BV _{DSS}	R _{DS(ON)}	I _D Tc = +25°C
80V	$7.8 \text{m}\Omega$ @ V _{GS} = 10V	83A

Description and Applications

This new generation MOSFET is designed to minimize $R_{DS(ON)}$ yet maintain superior switching performance. This device is ideal for use in power management and load switches.

- DC-DC converters
- Load switches

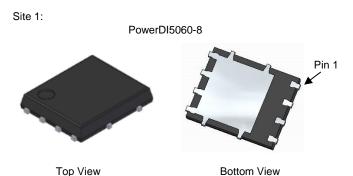
Features

- 100% Unclamped Inductive Switching (UIS) Test in Production Ensures More Reliable and Robust End Application
- High-Conversion Efficiency
- Low R_{DS(ON)} Minimizes On-State Losses
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- For automotive applications requiring specific change control (i.e. parts qualified to AEC-Q100/101/104/200, PPAP capable, and manufactured in IATF 16949 certified facilities), please contact us or your local Diodes representative.

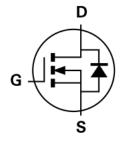
 https://www.diodes.com/quality/product-definitions/

Mechanical Data

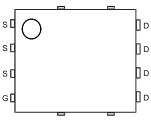
- Package: PowerDI[®]5060-8
- Package Material: Molded Plastic, "Green" Molding Compound.
 UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections: See Diagram Below
- Terminals: Finish Matte Tin Annealed over Copper Leadframe.
 Solderable per MIL-STD-202, Method 208 3
- Weight: 0.097 grams (Approximate)



Site 2:



Internal Schematic

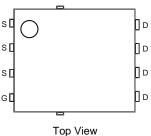


Top View Pin Configuration



Internal Schematic

S



Top View Pin Configuration



PowerDI5060-8/SWP (Type UX)

Top View

Bottom View

Notes:

- 1. EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant. All applicable RoHS exemptions applied.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.



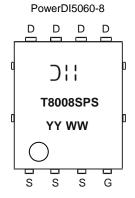
Ordering Information (Note 4)

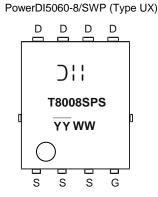
Part Number	Package	Packing		
Fait Number	Fackage	Qty.	Carrier	
DMT8008SPS-13	PowerDI5060-8	2,500	Tape & Reel	
DIVIT 60083F3-13	PowerDI5060-8/SWP (Type UX)	2,500	Tape & Reel	

Note:

4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

Marking Information





☐ National Series States The Series Series

Maximum Ratings (@Tc = +25°C, unless otherwise specified.)

Characteristic			Symbol	Value	Unit
Drain-Source Voltage			VDSS	80	V
Gate-Source Voltage			Vgss	±20	V
Continuous Drain Current, V _{GS} = 10V (Note 5)	Steady State	Tc = +25°C Tc = +70°C	ID	83 66	А
Maximum Continuous Body Diode Forward Current (Note 5)			Is	69	Α
Pulsed Drain Current (10µs Pulse, Duty Cycle = 1%)			I _{DM}	330	Α
Pulsed Body Diode Forward Current (10µs Pulse, Duty Cycle = 1%)			Ism	330	Α
Avalanche Current, L = 0.1mH (Note 6)			las	40	Α
Avalanche Energy, L = 0.1mH (Note 6)			Eas	80	mJ

Thermal Characteristics (@Tc = +25°C, unless otherwise specified.)

Characteristic		Symbol	Value	Unit
Total Power Dissipation (Note 7)	$T_A = +25$ °C	P _D	1.3	W
Thermal Resistance, Junction to Ambient (Note 7)	Steady State	RθJA	95	°C/W
Total Power Dissipation (Note 8)	T _A = +25°C	PD	2.8	W
Thermal Resistance, Junction to Ambient (Note 8)	Steady State	R _{θJA}	44	°C/W
Total Power Dissipation (Note 5)	Tc = +25°C	PD	83	W
Thermal Resistance, Junction to Case (Note 5)		Rejc	1.5	°C/W
Operating and Storage Temperature Range		TJ, TSTG	-55 to +150	°C

Notes:

- 5. Thermal resistance from junction to soldering point (on the exposed drain pad).
- 6. I_{AS} and E_{AS} ratings are based on low frequency and duty cycles to keep T_J = +25°C.
- 7. Device mounted on FR-4 PC board, with minimum recommended pad layout, single sided.
- 8. Device mounted on FR-4 substrate PC board, 2oz copper, with thermal bias to bottom layer 1inch square copper plate.



Electrical Characteristics (@T_C = +25°C, unless otherwise specified.)

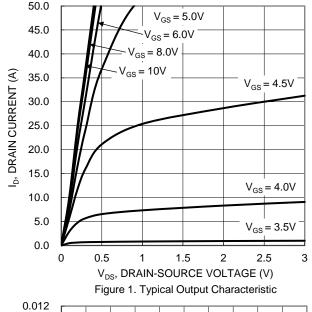
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 9)							
Drain-Source Breakdown Voltage	BV _{DSS}	80	_	_	V	VGS = 0V, ID = 1mA	
Zero Gate Voltage Drain Current	IDSS	_	_	1	μA	V _{DS} = 64V, V _{GS} = 0V	
Gate-Source Leakage	Igss	_	_	±100	nA	$V_{GS} = \pm 20V$, $V_{DS} = 0V$	
ON CHARACTERISTICS (Note 9)							
Gate Threshold Voltage	Vgs(TH)	2	_	4	V	V _{DS} = V _{GS} , I _D = 1mA	
Static Drain-Source On-Resistance	D	_	6.5	7.8	mΩ	$V_{GS} = 10V, I_D = 14A$	
Static Drain-Source On-Resistance	R _{DS(ON)}	_	7.8	11	11122	$V_{GS} = 6V, I_D = 12A$	
Diode Forward Voltage	VsD	_	8.0	1.2	V	V _G S = 0V, I _S = 14A	
DYNAMIC CHARACTERISTICS (Note 10)	DYNAMIC CHARACTERISTICS (Note 10)						
Input Capacitance	Ciss	_	1950	_			
Output Capacitance	Coss	_	826	_	pF	$V_{DS} = 40V$, $V_{GS} = 0V$ f = 1MHz	
Reverse Transfer Capacitance	Crss	_	56	_			
Gate Resistance	Rg	_	1.7	_	Ω	$V_{DS} = 0V$, $V_{GS} = 0V$, $f = 1MHz$	
Total Gate Charge (V _{GS} = 6V)	Qg	_	23	_			
Total Gate Charge (V _{GS} = 10V)	Qg	_	34	_	~C	V _{DS} = 40V, I _D = 14A	
Gate-Source Charge	Qgs	_	6	_	nC		
Gate-Drain Charge	Q_{gd}	_	12	_			
Turn-On Delay Time	td(ON)	_	8	_			
Turn-On Rise Time	t _R	_	15	_		$\begin{aligned} V_{DD} &= 40 \text{V, } V_{GS} = 10 \text{V} \\ I_D &= 14 \text{A, } R_g = 6 \Omega \end{aligned}$	
Turn-Off Delay Time	tD(OFF)	_	29	_	ns		
Turn-Off Fall Time	t _F	_	21	_			
Body Diode Reverse Recovery Time	t _{RR}	_	43	_	ns	1- 440 dl/dt 4000/us	
Body Diode Reverse Recovery Charge	Q _{RR}	_	49	_	nC	Is = 14A, dI/dt = 100A/μs	

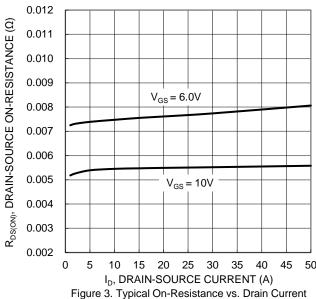
Notes:

Short duration pulse test used to minimize self-heating effect.
 Guaranteed by design. Not subject to product testing.









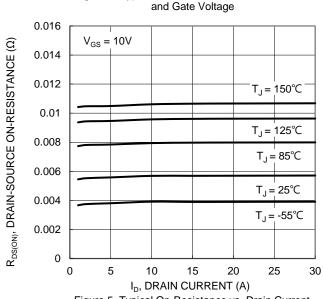


Figure 5. Typical On-Resistance vs. Drain Current and Temperature

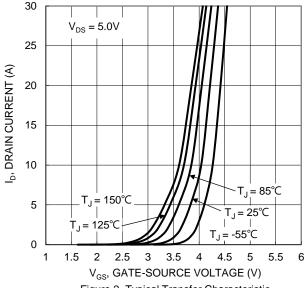
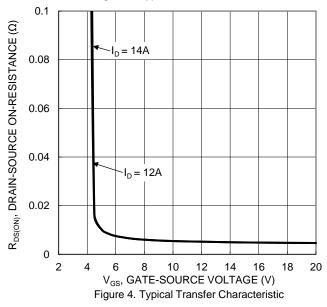


Figure 2. Typical Transfer Characteristic



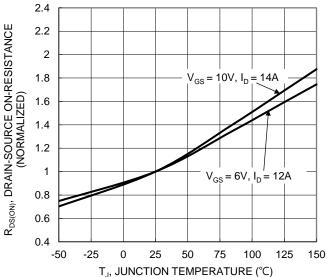
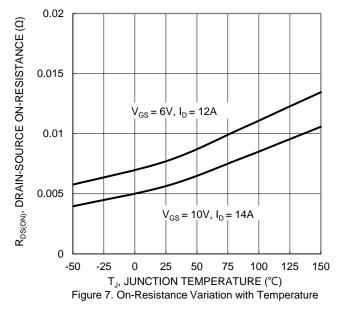
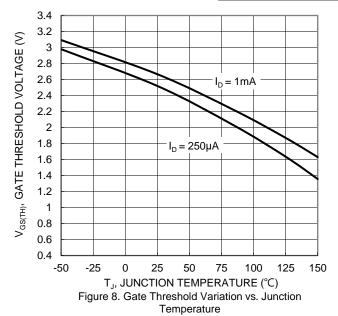


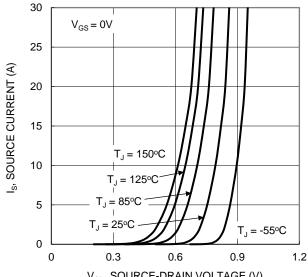
Figure 6. On-Resistance Variation with Temperature

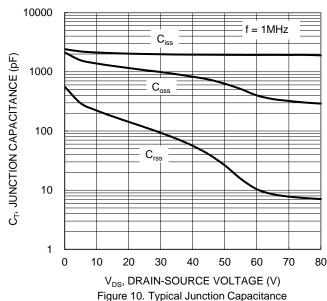














 $V_{DS} = 40V, I_{D} = 14A$

20

25

30



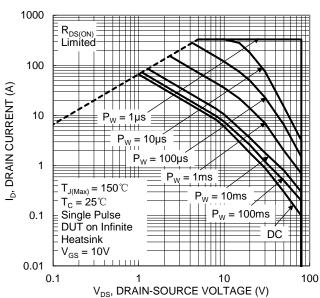


Figure 12. SOA, Safe Operation Area

5

10

15

 Q_g (nC) Figure 11. Gate Charge

10

8

6

4

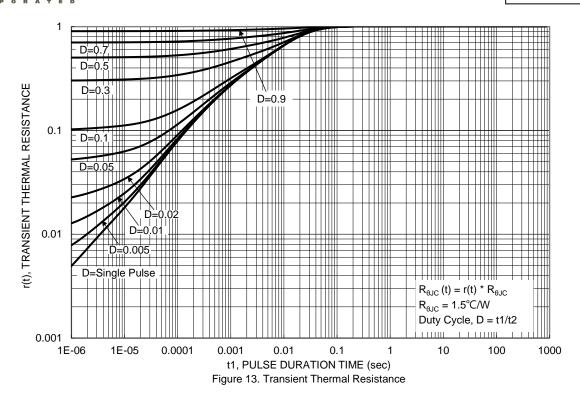
2

0

0

 $V_{GS}(V)$



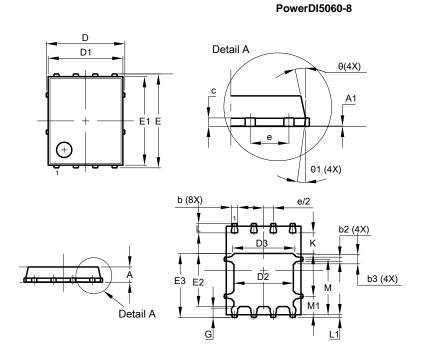




Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

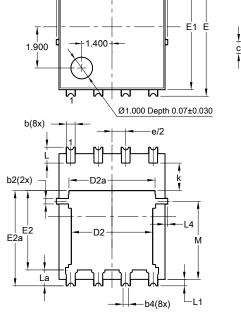
Site 1:

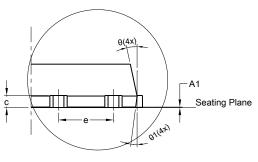


PowerDI5060-8				
Dim	Min	Max	Тур	
Α	0.90	1.10	1.00	
A1	0.00	0.05	-	
b	0.33	0.51	0.41	
b2	0.200	0.350	0.273	
b3	0.40	0.80	0.60	
С	0.230	0.330	0.277	
D	;	5.15 BSC	;	
D1	4.70	5.10	4.90	
D2	3.70	4.10	3.90	
D3	3.90	4.30	4.10	
Е	(6.15 BSC	•	
E1	5.60	6.00	5.80	
E2	3.28	3.68	3.48	
E3	3.99	4.39	4.19	
е		1.27 BSC	;	
G	0.51	0.71	0.61	
K	0.51	_	-	
L	0.51	0.71	0.61	
L1	0.100	0.200	0.175	
М	3.235	4.035	3.635	
M1	1.00	1.40	1.21	
Θ	10°	12°	11°	
Θ1	6°	8°	7°	
All Dimensions in mm				

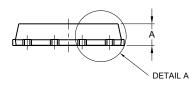
Site 2:

PowerDI5060-8/SWP (Type UX)





DETAIL A



PowerDI5060-8/SWP (Type UX)				
Dim	Min	Max	Тур	
Α	0.90	1.10	1.00	
A1	0	0.05		
b	0.30	0.50	0.41	
b2	0.20	0.35	0.25	
b4	().25REF		
С	0.230	0.330	0.277	
D	5	.15 BS0	\sim	
D1	4.70	5.10	4.90	
D2	3.56	3.96	3.76	
D2a	3.78	4.18	3.98	
Е	6	.40 BS0		
E1	5.60	6.00	5.80	
E2	3.46	3.86	3.66	
E2a	4.195	4.595	4.395	
е		.27BSC)	
k	1.05			
L	0.635	0.835	0.735	
La	0.635	0.835	0.735	
L1	0.200	0.400	0.300	
L1a	0.050REF			
L4	0.025	0.225	0.125	
М	3.205	4.005	3.605	
θ	10°	12°	11°	
θ1	6°	8°	7°	
All Dimensions in mm				

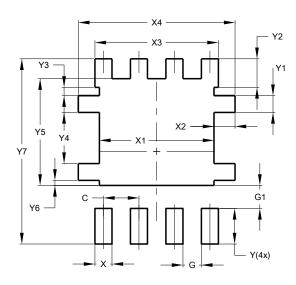


Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

Site 1:

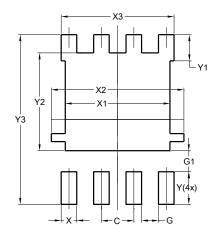
PowerDI5060-8



Dimensions	Value (in mm)
С	1.270
G	0.660
G1	0.820
Х	0.610
X1	4.100
X2	0.755
Х3	4.420
X4	5.610
Υ	1.270
Y1	0.600
Y2	1.020
Y3	0.295
Y4	1.825
Y5	3.810
Y6	0.180
Y7	6.610

Site 2:

PowerDI5060-8/SWP (Type UX)



Dimensions	Value (in mm)		
С	1.270		
G	0.660		
G1	0.820		
Х	0.610		
X1	4.100		
X2	5.190		
Х3	4.420		
Υ	1.270		
Y1	1.020		
Y2	3.810		
Y3	6.610		



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